400G OSFP400 to 4xQSFP56 100G IB HDR DAC
PN: V4C-P4QyyC-ENA

Product Overview

The V4C-P4QyyC-ENA is a 400G OSFP400 to 4xQSFP56 100G InfiniBand HDR Direct Attach Copper (DAC) breakout cable. It features an OSFP TYPE2 module compliant with the OSFP MSA and QSFP modules compliant with SFF-8665. Supporting transmission data rates up to PAM4 53.125Gbps per channel, it enables 400Gb/s to 4x100Gb/s transmission over link lengths up to 3 meters. This cable includes built-in EEPROM functions and operates within a case temperature range of 0°C to +70°C.

Features

- OSFP TYPE2 Module compliant to OSFP MSA
- QSFP Module compliant to SFF-8665
- Transmission data rate up to PAM4 53.125Gbps per channel
- Enable 400Gb/s to 4x100Gb/s Transmission
- Link length up to 3m
- Built-in EEPROM functions
- Operating case temperature 0°C to +70°C
- RoHS2.0 compliant

Ordering Information

Part Number	Description
V4C-P4QyyC-ENA	400G OSFP400 to 4xQSFP56 100G IB HDR DAC, yyy in meters

Absolute Maximum Ratings

Parameter	Symbol	Min	Typical	Max	Unit
Supply Voltage	Vcc	3.13	3.3	3.47	V
Storage temperature	Ts	-40		85	℃
Operating Case temperature	Tc	0		70	℃
Humidity	Rh	5		85	%
Data Rate			400		Gbps

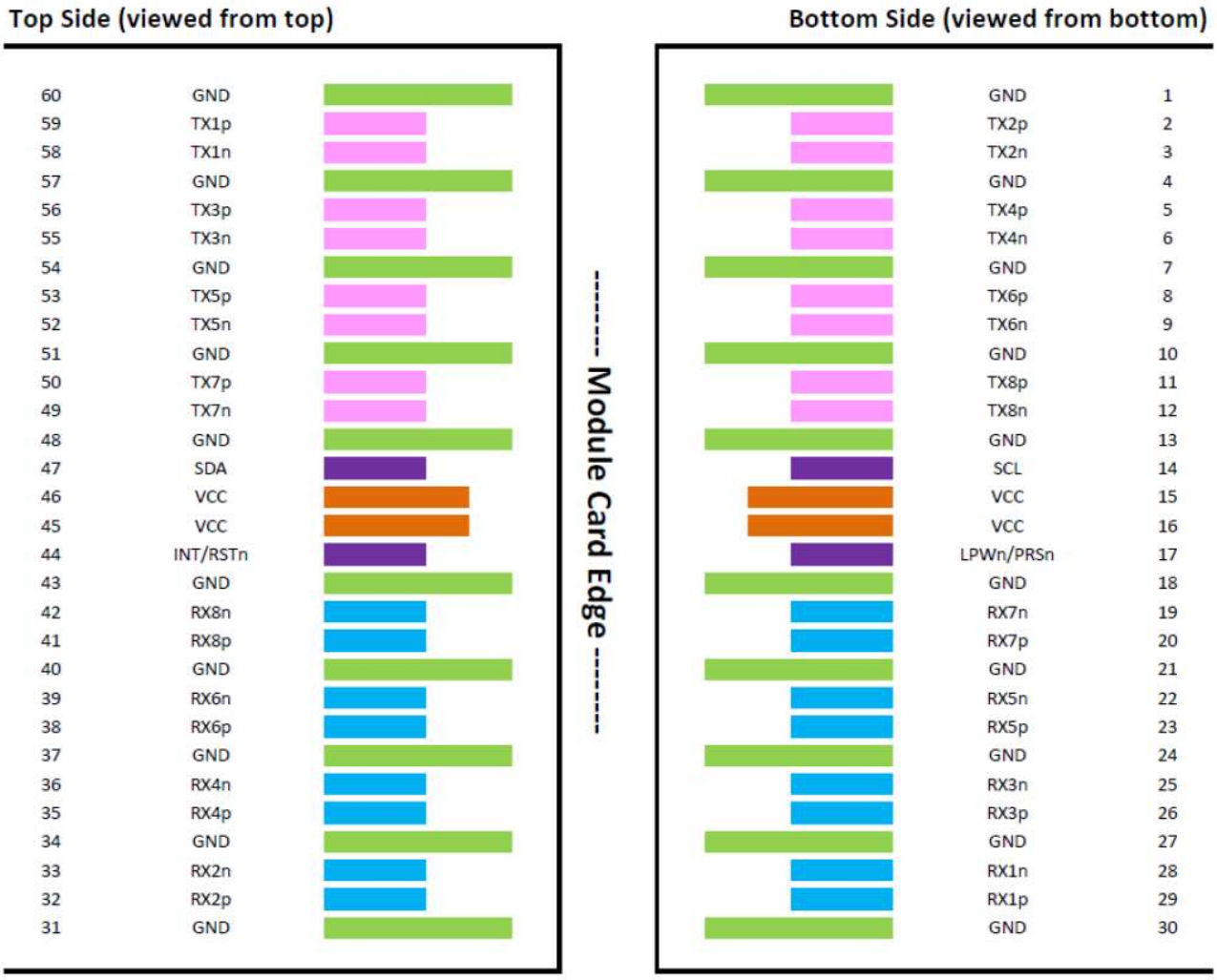
Physical Characteristics

Parameter	Symbol	Min	Typical	Max	Unit	Notes
Length	L	0.5		3.0	M	
AWG		30		25	AWG	
Jacket material		HAIRTAIL+ Technology Net, Silver Gray				

Electrical Specifications

Parameter	Symbol	Min	Typical	Max	Unit
Resistance	Rcon			3	ohm
Insulation Resistance	Rins			10	Mohm
Raw cable impedance	Zca	95	100	110	ohm
Mated connector Impedance	Zmated	85	100	115	ohm
Insertion loss at 13.28 GHz	SDD21	6		14	dB
Return loss	SDD11/22	Return_loss(f)≥ { 11 (0.05≤f< 26.5625/7.5); 6.0– 9.2lg(15f/ 5.5*7 26.5625) (26.5625/7.5≤f≤26.5) }			dB
Differential to common-mode return loss	SCD11/22	Return_loss(f)≥ { -25+(20/26.5625)f (0.05≤f< 26.5625/2); -18+(6/26.5625)f (26.5625/2≤f≤26.5625) }			dB
Differential to common-mode conversion loss	SCD21-SDD21	Conversion _loss(f) – IL(f)≥ { 10 (0.05≤f< 26.5625/7.5); 27-(29/22)f (12.89≤f<15.7); 6.3 (15.7≤f≤19) }			dB
Minimum COM	COM	3			dB

Electrical Connector Layout OSFP

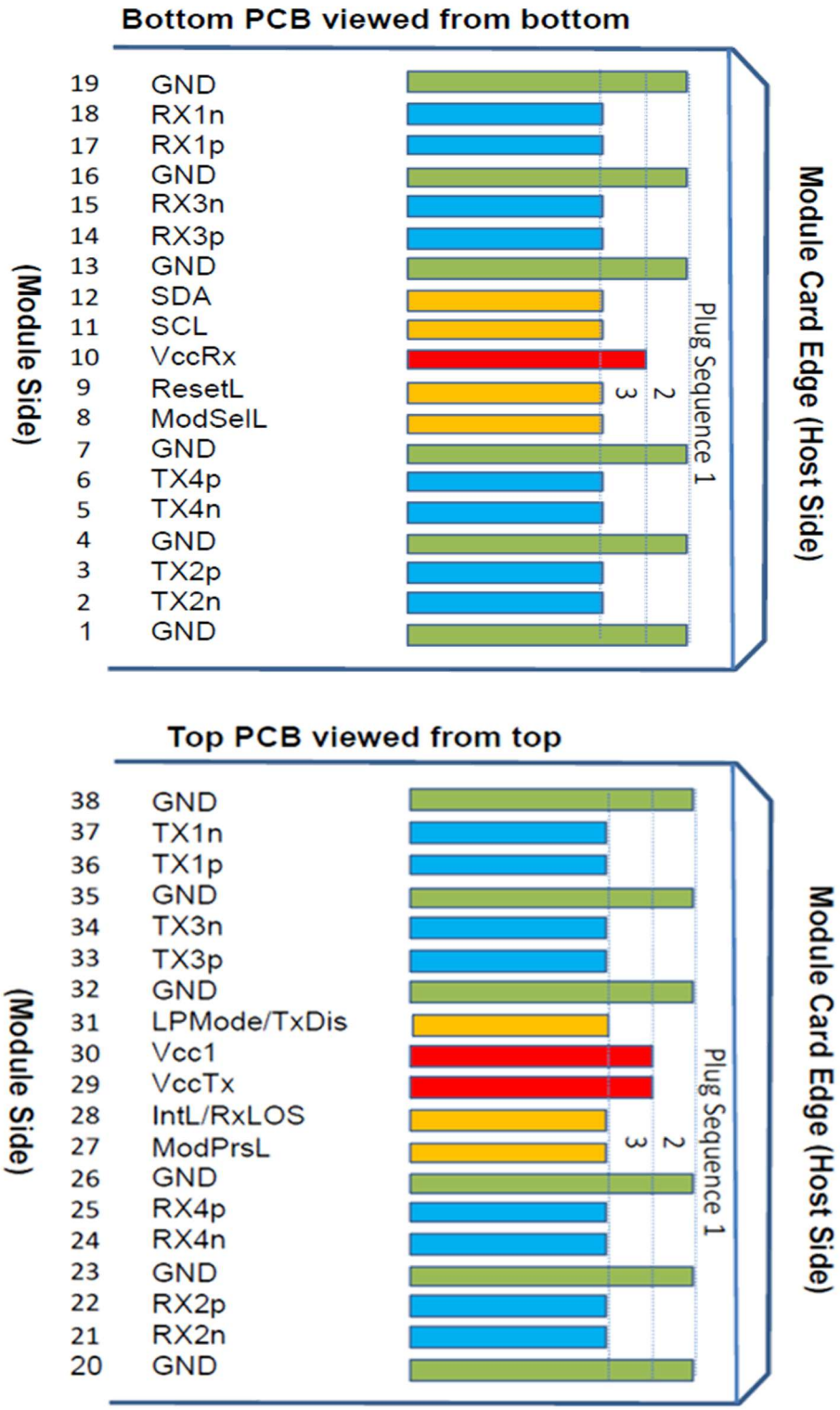


Electrical Pin Definition

Pin#	Symbol	Description	Logic	Direction	Plug Sequence	Notes
1	GND	Ground			1	
2	TX2p	Transmitter Data Non-Inverted	CML-I	Input from Host	3	
3	TX2n	Transmitter Data Inverted	CML-I	Input from Host	3	
4	GND	Ground			1	
5	TX4p	Transmitter Data Non-Inverted	CML-I	Input from Host	3	
6	TX4n	Transmitter Data Inverted	CML-I	Input from Host	3	
7	GND	Ground			1	
8	TX6p	Transmitter Data Non-Inverted	CML-I	Input from Host	3	
9	TX6n	Transmitter Data Inverted	CML-I	Input from Host	3	
10	GND	Ground			1	
11	TX8p	Transmitter Data Non-Inverted	CML-I	Input from Host	3	
12	TX8n	Transmitter Data Inverted	CML-I	Input from Host	3	
13	GND	Ground			1	
14	SCL	2-wire Serial interface clock	LVCMOS-I/O	Bi-directional	3	Open-Drain with pull-up resistor on Host
15	VCC	+3.3V Power		Power from Host	2	
16	VCC	+3.3V Power		Power from Host	2	
17	LPWn/PRSn	Low-Power Mode / Module Present	Multi-Level	Bi-directional	3	See pin description for required circuit
18	GND	Ground			1	
19	RX7n	Receiver Data Inverted	CML-O	Output to Host	3	
20	RX7p	Receiver Data Non-Inverted	CML-O	Output to Host	3	
21	GND	Ground			1	
22	RX5n	Receiver Data Inverted	CML-O	Output to Host	3	
23	RX5p	Receiver Data Non-Inverted	CML-O	Output to Host	3	
24	GND	Ground			1	
25	RX3n	Receiver Data Inverted	CML-O	Output to Host	3	
26	RX3p	Receiver Data Non-Inverted	CML-O	Output to Host	3	
27	GND	Ground			1	
28	RX1n	Receiver Data Inverted	CML-O	Output to Host	3	
29	RX1p	Receiver Data Non-Inverted	CML-O	Output to Host	3	
30	GND	Ground			1	

Pin#	Symbol	Description	Logic	Direction	Plug Sequence	Notes
31	GND	Ground			1	
32	RX2p	Receiver Data Non-Inverted	CML-O	Output to Host	3	
33	RX2n	Receiver Data Inverted	CML-O	Output to Host	3	
34	GND	Ground			1	
35	RX4p	Receiver Data Non-Inverted	CML-O	Output to Host	3	
36	RX4n	Receiver Data Inverted	CML-O	Output to Host	3	
37	GND	Ground			1	
38	RX6p	Receiver Data Non-Inverted	CML-O	Output to Host	3	
39	RX6n	Receiver Data Inverted	CML-O	Output to Host	3	
40	GND	Ground			1	
41	RX8p	Receiver Data Non-Inverted	CML-O	Output to Host	3	
42	RX8n	Receiver Data Inverted	CML-O	Output to Host	3	
43	GND	Ground			1	
44	INT/RSTn	Module Interrupt / Module Reset	Multi-Level	Bi-directional	3	See pin description for required circuit
45	VCC	+3.3V Power		Power from Host	2	
46	VCC	+3.3V Power		Power from Host	2	
47	SDA	2-wire Serial interface data	LVCMOS-I/O	Bi-directional	3	Open-Drain with pull-up resistor on Host
48	GND	Ground			1	
49	TX7n	Transmitter Data Inverted	CML-I	Input from Host	3	
50	TX7p	Transmitter Data Non-Inverted	CML-I	Input from Host	3	
51	GND	Ground			1	
52	TX5n	Transmitter Data Inverted	CML-I	Input from Host	3	
53	TX5p	Transmitter Data Non-Inverted	CML-I	Input from Host	3	
54	GND	Ground			1	
55	TX3n	Transmitter Data Inverted	CML-I	Input from Host	3	
56	TX3p	Transmitter Data Non-Inverted	CML-I	Input from Host	3	
57	GND	Ground			1	
58	TX1n	Transmitter Data Inverted	CML-I	Input from Host	3	
59	TX1p	Transmitter Data Non-Inverted	CML-I	Input from Host	3	
60	GND	Ground			1	

Electrical Connector Layout QSFP

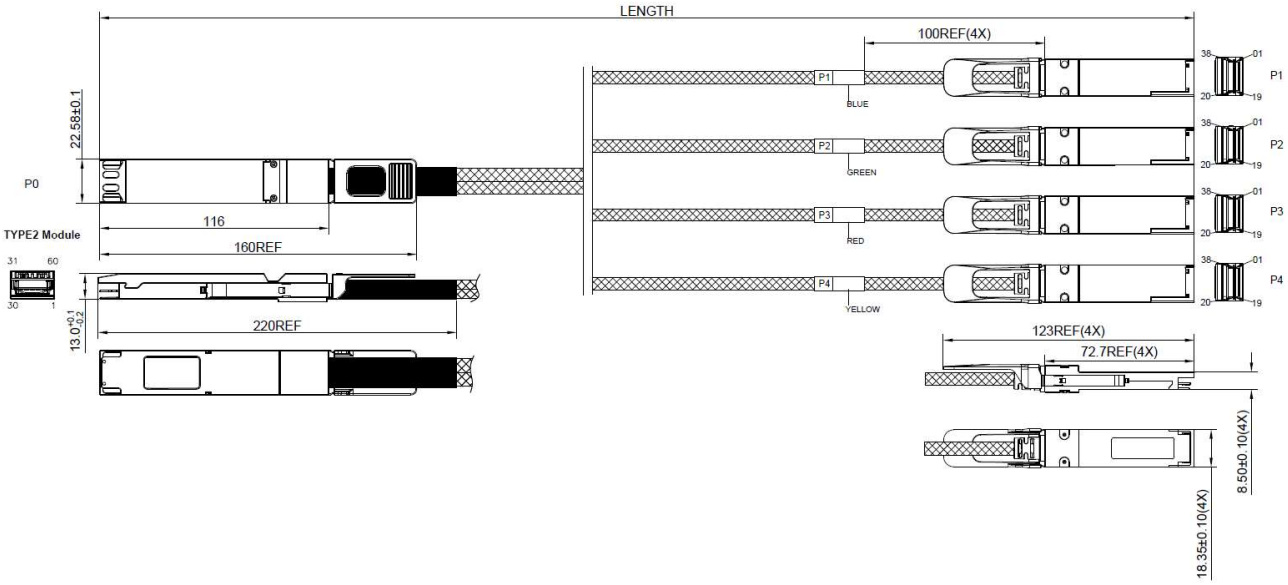


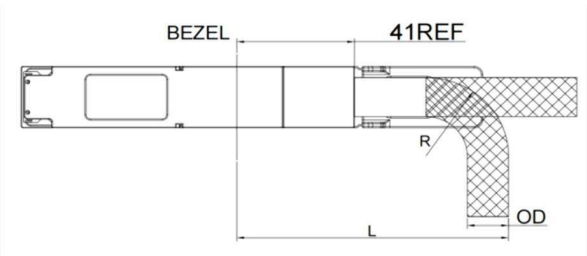
Electrical Pin Definition

Pad	Logic	Symbol	Description	Plug Sequence[4]	Notes
1		GND	Ground	1	1
2	CML-I	Tx2n	Transmitter Inverted Data Input	3	
3	CML-I	Tx2p	Transmitter Non-Inverted Data Input	3	
4		GND	Ground	1	1
5	CML-I	Tx4n	Transmitter Inverted Data Input	3	
6	CML-I	Tx4p	Transmitter Non-Inverted Data Input	3	
7		GND	Ground	1	1
8	LVTTL-I	ModSelL	Module Select	3	
9	LVTTL-I	ResetL	Module Reset	3	
10		VccRx	+3.3V Power Supply Receiver	2	2
11	LVCMOS-I/O	SCL	TWI serial interface clock	3	
12	LVCMOS-I/O	SDA	TWI serial interface data	3	
13		GND	Ground	1	1
14	CML-O	Rx3p	Receiver Non-Inverted Data Output	3	
15	CML-O	Rx3n	Receiver Inverted Data Output	3	
16		GND	Ground	1	1
17	CML-O	Rx1p	Receiver Non-Inverted Data Output	3	
18	CML-O	Rx1n	Receiver Inverted Data Output	3	
19		GND	Ground	1	1
20		GND	Ground	1	1
21	CML-O	Rx2n	Receiver Inverted Data Output	3	
22	CML-O	Rx2p	Receiver Non-Inverted Data Output	3	
23		GND	Ground	1	1
24	CML-O	Rx4n	Receiver Inverted Data Output	3	
25	CML-O	Rx4p	Receiver Non-Inverted Data Output	3	
26		GND	Ground	1	1
27	LVTTL-O	ModPrsL	Module Present	3	
28	LVTTL-O	IntL/ RxLOS	Interrupt/optional RxLOS	3	
29		VccTx	+3.3V Power supply transmitter	2	2
30		Vcc1	+3.3V Power supply	2	2
31	LVTTL-I	LPMode/ TxDis	Low Power mode/optional TX Disable	3	
32		GND	Ground	1	1
33	CML-I	Tx3p	Transmitter Non-Inverted Data Input	3	
34	CML-I	Tx3n	Transmitter Inverted Data Input	3	
35		GND	Ground	1	1
36	CML-I	Tx1p	Transmitter Non-Inverted Data Input	3	
37	CML-I	Tx1n	Transmitter Inverted Data Input	3	
38		GND	Ground	1	1

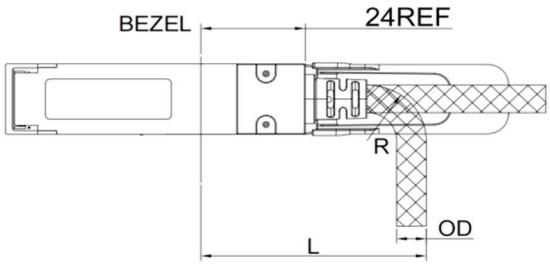
Note 1: QSFP112 uses common ground (GND) for all signals and supply (power). All are common within the QSFP-DD module and all module voltages are referenced to this potential unless otherwise noted. Connect these directly to the host board signal-common ground plane. Each connector Gnd contact is rated for a maximum current of 500 mA.
Note 2: VccRx, Vcc1, and VccTx shall be applied concurrently. Supply requirements defined for the host side of the Host Card Edge Connector are listed in Table 13. For power classes 4 and above the module differential loading of input voltage pads must not result in exceeding contact current limits. Each connector Vcc contact is rated for a maximum current of 1500 mA.
Note 4: Plug Sequence specifies the mating sequence of the host connector and module. The sequence is 1, 2, and 3 see Figure 14 for pad locations.

Mechanical Dimensions





OSFP TYPE2			
GAUGE	OD	BEND RADIUS "R"	MIN. BEND RADIUS "L"
30AWG	9.5MM	19MM	80MM
26/25AWG	12.1MM	25MM	86MM



OSFP TYPE2			
GAUGE	OD	BEND RADIUS "R"	MIN. BEND RADIUS "L"
30AWG	9.5MM	19MM	80MM
26/25AWG	12.1MM	25MM	86MM

Revision History

Date	Rev	Description
2/1/2024	1.0	Release Version
03/17/2025	1.1	New Template

For more information

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